

Product Change Notification / BLAS-22EYRT357

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25-Jan-2024

Product Category:

High Voltage Power Modules

PCN Type:

Manufacturing Change

Notification Subject:

CCB 6814 Final Notice: Qualification of INMK as an additional fabrication site for selected Microsemi Power Module products.

Affected CPNs:

BLAS-22EYRT357_Affected_CPN_01252024.pdf BLAS-22EYRT357_Affected_CPN_01252024.csv

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of INMK as an additional fabrication site for selected Microsemi Power Module products.

Pre and Post Change Summary:

Pre Change	Post Change
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Fabrication Site	Infineon Technologies Austria AG	Infineon Technologies Austria AG	Infineon Technologies (Kulim) Sdn. Bhd.		
	(INFA)	(INFA)	(INMK)		
Wafer Diameter	6 Inches	6 Inches	8 Inches		
Certification	ISO-9001 / IATF16949	ISO-9001 / IATF16949	ISO-9001		

Impacts to Data Sheet:None

Change Impact:None

Reason for Change:To improve on-time delivery performance by qualifying INMK as an additional fabrication site.

Change Implementation Status:In Progress

Estimated First Ship Date: April 01, 2024 (date code: 2414)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	January 2024				>	April 2024					
Workweek	0 1	0 2	0 3	0 4	0 5		1 4	1 5	1 6	1 7	1 8
Qual Report Availability				Х							
Final PCN Issue Date				Х							
Estimated Implementation Date							Х				

Method to Identify Change:Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History: January 25, 2024: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_BLAS-22EYRT357_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

APT50DF170HJ

APT75DF170HJ

APTDF400AA170G

APTDF400AK170G

APTDF400KK170G

APTGT100A170TG

APTGT100DU170TG

APTGT100H170G

APTGT100SK170TG

APTGT100TL170G

APTGT150A170TG

APTGT150DH170G

APTGT150SK170G

APTGT200A170D3G

APTGT225A170G

APTGT225DU170G

APTGT225SK170G

APTGT300A170D3G

APTGT300A170G

APTGT300DA170D3G

APTGT300DA170G

APTGT300DU170G

APTGT300SK170G

APTGT30A170T1G

APTGT30H170T3G

APTGT400U170D4G

APTGT400U170DAG

APTGT50A170T1G

APTGT50A170TG

APTGT50DH170TG

APTGT50H170TG

APTGT50SK170T1G

APTGT50SK170TG

APTGT50TDU170PG

APTGT600U170D4G

CMAEDF200KK330D1G

CMIEDF75V1701G

CMLRDF50X1701MVXG-AS

MSCSMG170ANPCM15TPAG